

Features

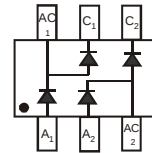
- Two Series Diode Circuits Connect to Form Full Wave Bridge
- Fast Switching Speed
- High Conductance
- High Reverse Breakdown Voltage Rating
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: SOT-26
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Matte Tin Finish Annealed over Copper Leadframe
(Lead-Free Plating). Solderable per MIL-STD-202, Method 208 
- Polarity: See Diagram
- Weight: 0.016 grams (Approximate)



SOT-26
Top View



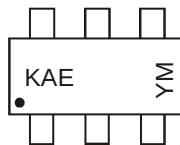
Top View
Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
MMBD3004BRM-7-F	SOT-26	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free..
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



KAE = Product Type Marking Code
YM = Date Code Marking
Y = Year ex: F = 2018
M = Month ex: 9 = September

Date Code Key

Year	2006	2007	...	2017	2018	2019	2020	2021	2022	2023	2024	2025
Code	T	U	...	E	F	G	H	I	J	K	L	M

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	350	V
Working Peak Reverse Voltage	V _{RWM}	300	V
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	212	V
Forward Continuous Current (Note 5)	I _F	225	mA
Peak Repetitive Forward Current (Note 5)	I _{FRM}	625	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	4.0	A
		1.0	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{ΘJA}	357	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	350	—	—	V	I _R = 150μA
Forward Voltage	V _F	—	0.78 0.93 1.03	0.87 1.0 1.25	V	I _F = 20mA I _F = 100mA I _F = 200mA
Reverse Current (Note 6)	I _R	—	30 35	100 100	nA μA	V _R = 240V V _R = 240V, T _J = +150°C
Total Capacitance	C _T	—	1.0	5.0	pF	V _R = 0V, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	—	50	ns	I _F = I _R = 30mA, I _{rr} = 3.0mA, R _L = 100Ω

Notes: 5. Part mounted on FR-4 board 1 inch squared cu pad layout.
6. Short duration pulse test used to minimize self-heating effect.

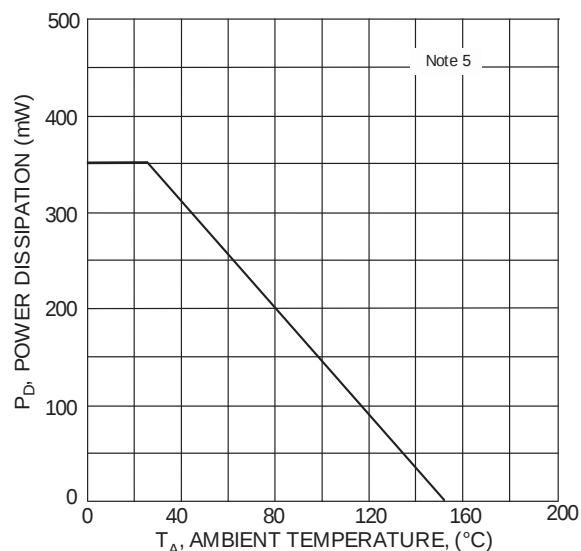


Fig. 1 Power Derating Curve, Total Package

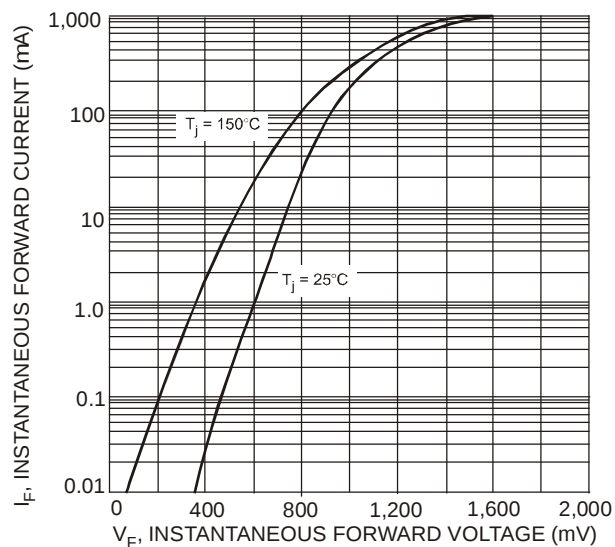


Fig. 2 Typical Forward Characteristics, Per Element

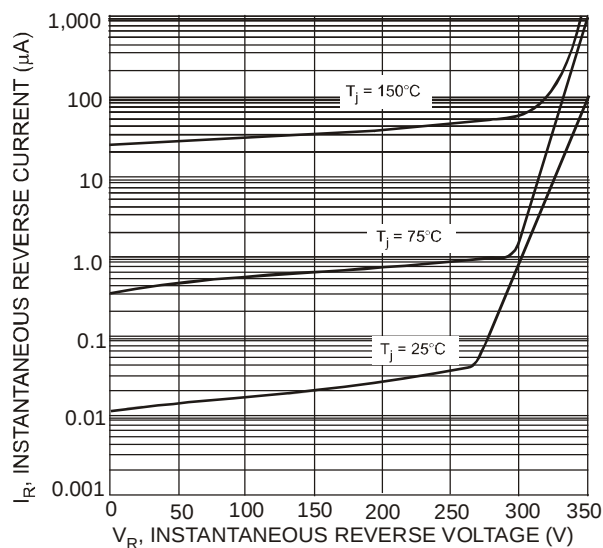


Fig. 3 Typical Reverse Characteristics, Per Element

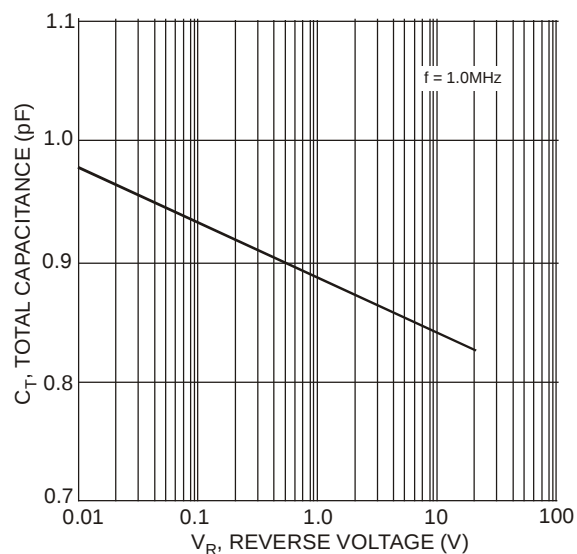
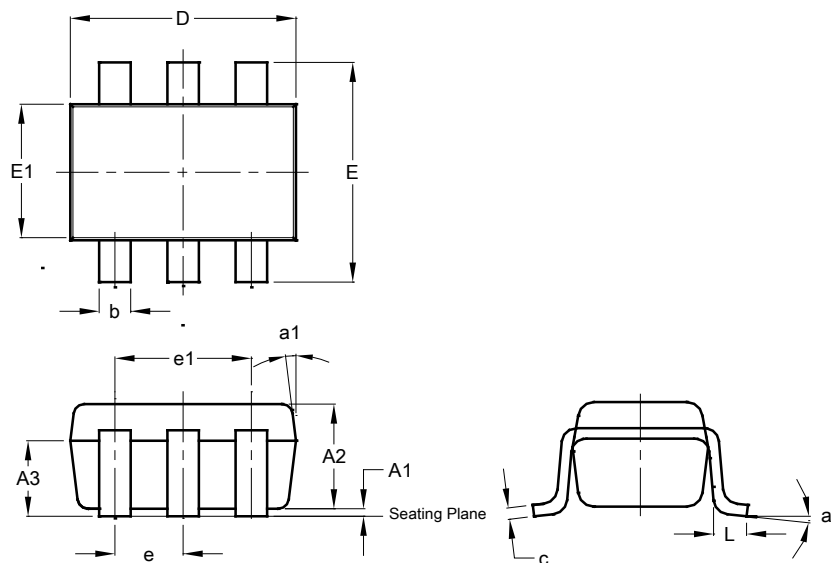


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT26 (SC74R)

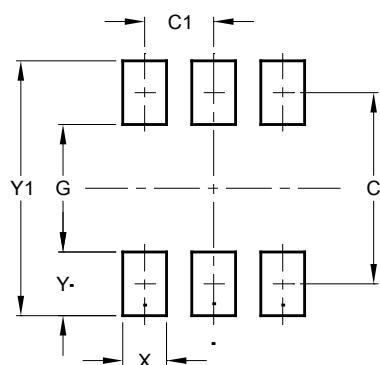


SOT26 (SC74R)			
Dim	Min	Max	Typ
A1	0.013	0.10	0.05
A2	1.00	1.30	1.10
A3	0.70	0.80	0.75
b	0.35	0.50	0.38
c	0.10	0.20	0.15
D	2.90	3.10	3.00
e	—	—	0.95
e1	—	—	1.90
E	2.70	3.00	2.80
E1	1.50	1.70	1.60
L	0.35	0.55	0.40
a	—	—	8°
a1	—	—	7°
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT26 (SC74R)



Dimensions	Value (in mm)
C	2.40
C1	0.95
G	1.60
X	0.55
Y	0.80
Y1	3.20

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